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NOV 01 2004**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Brenner

Art Unit: 2814

Serial No.: 10/038,813

Examiner: Trinh, Hoa B.

Filed: 31 December 2001

Docket No. TI-30637

For: SEPARATING WAFERS COATED WITH PLASTIC FILMS

CERTIFICATION OF FACSIMILE TRANSMISSION

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NAME OF INVENTOR(S): Miller et al.	
TITLE OF INVENTION: SEPARATING WAFERS COATED WITH PLASTIC FILMS	
TI FILE NO.: TI-30637	DEPOSIT ACCT. NO.: 20-0668
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